Doc code: IDS Doc description: Information Disclosure Statement (IDS) Filed

PTO/SB/08a (01-10)

Approved for use through 07/31/2012. OMB 0651-0031

Mation Disclosure Statement (IDS) Filed

U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

| INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99) | Application Number | | 10598515 | | |
|--|-----------------------------|-------|------------|--|--|
| | Filing Date | | 2006-09-01 | | |
| | First Named Inventor Seiich | | chi AKAGI | | |
| | Art Unit | | 1796 | | |
| | Examiner Name | Hanna | ah J. Pak | | |
| | Attorney Docket Numb | er | MIYOSH0008 | | |

| U.S.PATENTS | | | | | | | | | Remove | | |
|--|----------------------------|-----------------------------|--------------------------------|---------------------|---------------------------|-------------------------------|--|--|---|----------|------------|
| Examiner Initial* | Cite No | Patent Number | Kind Code ¹ | Issue D |)ate | Name of Pate of cited Docu | Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear | | | | |
| | 1 | | | | | | | | | | |
| If you wish to add additional U.S. Patent citation information please click the Add button. | | | | | | | | | | | |
| | Remove | | | | | | | | | | |
| Examiner Initial* | Cite No Publication Number | | Kind Code ¹ | Publication Date | | of cited Document | | Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear | | | |
| | 1 | | | | | | | | | | |
| If you wish to add additional U.S. Published Application citation information please click the Add button. Add | | | | | | | | | | | |
| | | | | FOREIG | SN PAT | ENT DOCUM | ENTS | | Remove | | |
| Examiner Initial* | | Foreign Document Number³ | Country Code ² j | | Kind Code ⁴ | Publication Date | Applicant of cited | | Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear | | T 5 |
| | 1 | 03-115424 | JP | | | 1991-05-16 | Toshiba Corp. | | w/ English Abstract | | |
| | 2 | 2003-064242 | JP | | | 2003-03-05 | Sumitomo Bakelite Co. Ltd. | | v/ English <i>F</i> | Abstract | |
| | 3 | 2003-327791 | JP | | | 2003-11-19 | Hitachi Chem. Co. Ltd. v | | v/ English <i>A</i> | Abstract | |

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Not for submission under 37 CFR 1.99)

| Application Number | | 10598515 | | | | |
|------------------------|---------------|---------------|--|--|--|--|
| Filing Date | | 2006-09-01 | | | | |
| First Named Inventor | Seiich | Seiichi AKAGI | | | | |
| Art Unit | | 1796 | | | | |
| Examiner Name | Hannah J. Pak | | | | | |
| Attorney Docket Number | | MIYOSH0008 | | | | |

| | 4 | 2003-19 | 2876 | JP | | 2003-07-09 | Nitto Denko Corp. | w/ English Abstr | act | | |
|---|--|---|------|-----------------|---------|------------|------------------------|------------------|-----|--|--|
| | 5 | 2002-36 | 3251 | JP | | 2002-12-18 | Hitachi Chem. Co. Ltd. | w/ English Abstr | act | | |
| | 6 | 06-1077 | '58 | JP | | 1994-04-19 | Nitto Denko Corp. | w/ English Abstr | act | | |
| | 7 | 06-1283 | 62 | JP | | 1994-05-10 | Nitto Denko Corp. | w/ English Abstr | act | | |
| If you wish | If you wish to add additional Foreign Patent Document citation information please click the Add button Add | | | | | | | | | | |
| | | | | NON-PATEN | NT LITE | RATURE DO | CUMENTS | Remove | | | |
| Examiner Initials* | Cite No | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, pages(s), volume-issue number(s), publisher, city and/or country where published. | | | | | | | | | |
| | 1 | Office Action issued in counterpart Japanese Application No. 2006-51075, dated April 27, 2010. | | | | | | | | | |
| If you wish to add additional non-patent literature document citation information please click the Add button Add | | | | | | | | | | | |
| EXAMINER SIGNATURE | | | | | | | | | | | |
| Examiner Signature | | | | Date Considered | | | | | | | |
| *EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through a citation if not in conformance and not considered. Include copy of this form with next communication to applicant. | | | | | | | | | | | |
| ¹ See Kind Codes of USPTO Patent Documents at <u>www.USPTO.GOV</u> or MPEP 901.04. ² Enter office that issued the document, by the two-letter code (WIPO Standard ST.3). ³ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁴ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁵ Applicant is to place a check mark here if English language translation is attached. | | | | | | | | | | | |